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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

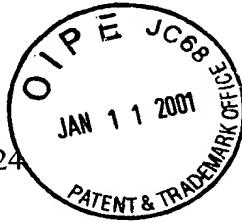
In re the Application of

Masahiko YANAGISAWA

Application No.: 09/674,924

Docket No.: 105013

Filed: November 8, 2000



For: FLEXIBLE INTERCONNECT SUBSTRATE, FILM CARRIER, TAPE-SHAPED SEMICONDUCTOR DEVICE, SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME, CIRCUIT BOARD, AND ELECTRONIC EQUIPMENT

REQUEST FOR CORRECTION OF PALM RECORDS

Director of the U.S. Patent and Trademark Office
Washington, D.C. 20231

Sir:

Attached is a photocopy of the original filing receipt on which errors have been corrected in red. These errors are being brought to the attention of the Patent and Trademark Office so that it may correct its records.

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Respectfully submitted,



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Date: January 11, 2001

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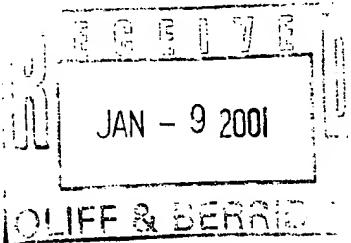
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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/674,924	11/08/2000	2811	932	105013	8	24	1

 Oliff & Berridge
 PO Box 19928
 Alexandria, VA 22320


FILING RECEIPT



OC000000005653690

Date Mailed: 01/04/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Masahiko Yanagisawa, Nagano-ken, JAPAN; Chino-shi

Continuing Data as Claimed by Applicant

THIS APPLICATION IS A 371 OF PCT/JP00/01388 03/08/2000

 REC'D
 FEB 23 2001
 TO 2800 MAIL ROOM

Foreign Applications

JAPAN 11-065226 03/11/1999

If Required, Foreign Filing License Granted 01/04/2001

Title

 interconnect *tape-shaped*
 Flexible wiring substrate, film carrier, *tape-like* semiconductor device, semiconductor device/
 and method of manufacture of *semiconductor device*, circuit board, and electronic device/
manufacturing the same equipment

Preliminary Class

257

Data entry by : ORDENEZ, MARTA

Team : OIPE

Date: 01/04/2001

